

MKDSP 10N/ 2-10,16SZSBDSE RD,ERD - PCB terminal block



1774124

<https://www.phoenixcontact.com/pc/products/1774124>

Please be informed that the data shown in this PDF document is generated from our online catalog. Please find the complete data in the user documentation. Our general terms of use for downloads are valid.



PCB terminal block, nominal current: 76 A, rated voltage (III/2): 1000 V, nominal cross section: 16 mm², number of potentials: 2, number of rows: 1, number of positions per row: 2, product range: MKDSP 10N, pitch: 10.16 mm, connection method: Screw connection with tension sleeve, screw head form: L Slotted, mounting: Wave soldering, conductor/PCB connection direction: 0 °, Pin layout: Linear double pinning, Solder pin [P]: 5 mm, number of solder pins per potential: 2, type of packaging: packed in cardboard

Your advantages

- Well-known connection principle allows worldwide use
- Low temperature rise, thanks to maximum contact force
- Allows connection of two conductors
- Quick and convenient testing using integrated test option
- The latching on the side enables various numbers of positions to be combined
- Integrated protective guide prevents incorrect insertion of the conductor underneath the tension sleeve

Commercial data

Item number	1774124
Packing unit	50 pc
Minimum order quantity	1 pc
Note	Made to order (non-returnable)
Product key	AANFFF
GTIN	4046356481571
Weight per piece (including packing)	15.122 g
Weight per piece (excluding packing)	15.122 g
Customs tariff number	85369010
Country of origin	PL

MKDSP 10N/ 2-10,16SZSBDSE RD,ERD - PCB terminal block



1774124

<https://www.phoenixcontact.com/pc/products/1774124>

Technical data

Product properties

Product type	Printed circuit board terminal
Product family	MKDSP 10N
Product line	COMBICON Terminals L
Type	PC terminal block can be aligned
Number of positions	2
Pitch	10.16 mm
Number of connections	2
Number of rows	1
Number of potentials	2
Pin layout	Linear double pinning
Solder pins per potential	2

Electrical properties

Nominal current I_N	76 A
Nominal voltage U_N	1000 V
Degree of pollution	3
Rated voltage (III/3)	690 V
Rated surge voltage (III/3)	8 kV
Rated voltage (III/2)	1000 V
Rated surge voltage (III/2)	8 kV
Rated voltage (II/2)	1000 V
Rated surge voltage (II/2)	6 kV

Connection data

Connection technology

Type	PC terminal block can be aligned
Nominal cross section	16 mm ²

Conductor connection

Connection method	Screw connection with tension sleeve
Conductor cross section rigid	0.5 mm ² ... 16 mm ²
Conductor cross section flexible	0.5 mm ² ... 16 mm ²
Conductor cross section AWG	20 ... 6
Conductor cross section flexible, with ferrule without plastic sleeve	0.5 mm ² ... 16 mm ²
Conductor cross section, flexible, with ferrule, with plastic sleeve	0.5 mm ² ... 16 mm ²
2 conductors with same cross section, solid	0.5 mm ² ... 4 mm ²
2 conductors with same cross section, flexible	0.5 mm ² ... 4 mm ²
2 conductors with same cross section, flexible, with ferrule without plastic sleeve	0.5 mm ² ... 2.5 mm ²
2 conductors with the same cross section, flexible, with TWIN	0.5 mm ² ... 6 mm ²

MKDSP 10N/ 2-10,16SZSBDSE RD,ERD - PCB terminal block



1774124

<https://www.phoenixcontact.com/pc/products/1774124>

ferrule with plastic sleeve	
Stripping length	10 mm
Tightening torque	1.2 Nm ... 1.5 Nm

Mounting

Mounting type	Wave soldering
Pin layout	Linear double pinning
Drive form screw head	Slotted (L)

Material specifications

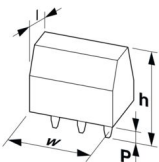
Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface terminal point (top layer)	Tin (5 - 7 μm Sn)
Metal surface terminal point (middle layer)	Nickel (2 - 3 μm Ni)
Metal surface soldering area (top layer)	Tin (5 - 7 μm Sn)
Metal surface soldering area (middle layer)	Nickel (2 - 3 μm Ni)

Material data - housing

Color ()	()
Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	125 °C

Dimensions

Dimensional drawing	
Pitch	10.16 mm
Width [w]	20.32 mm
Height [h]	34.3 mm
Length [l]	18.4 mm
Installed height	29.3 mm
Solder pin length [P]	5 mm

MKDSP 10N/ 2-10,16SZSBDSE RD,ERD - PCB terminal block



1774124

<https://www.phoenixcontact.com/pc/products/1774124>

Pin dimensions	1 x 0.9 mm
PCB design	
Hole diameter	1.5 mm

Mechanical tests

Test for conductor damage and slackening

Specification	IEC 60998-2-1:2002-12
Result	Test passed

Pull-out test

Specification	IEC 60998-2-1:2002-12
Conductor cross section/conductor type/tractive force setpoint/actual value	0.5 mm ² / solid / > 20 N
	0.5 mm ² / flexible / > 20 N
	16 mm ² / solid / > 100 N
	16 mm ² / flexible / > 100 N

Torque test

Specification	IEC 60998-2-1:2002-12
---------------	-----------------------

Electrical tests

Temperature-rise test

Specification	IEC 60998-1:2002-12
Requirement temperature-rise test	Increase in temperature ≤ 45 K

Insulation resistance

Specification	IEC 60998-1:2002-12
Insulation resistance, neighboring positions	> 5 MΩ

Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	I
Comparative tracking index (IEC 60112)	CTI 600
Rated insulation voltage (III/3)	690 V
Rated surge voltage (III/3)	8 kV
minimum clearance value - non-homogenous field (III/3)	8 mm
minimum creepage distance (III/3)	8 mm
Rated insulation voltage (III/2)	1000 V
Rated surge voltage (III/2)	8 kV
minimum clearance value - non-homogenous field (III/2)	8 mm
minimum creepage distance (III/2)	8 mm
Rated insulation voltage (II/2)	1000 V
Rated surge voltage (II/2)	6 kV
minimum clearance value - non-homogenous field (II/2)	5.5 mm
minimum creepage distance (II/2)	5.5 mm

MKDSP 10N/ 2-10,16SZSBDSE RD,ERD - PCB terminal block



1774124

<https://www.phoenixcontact.com/pc/products/1774124>

Environmental and real-life conditions

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	5g (60.1 Hz ... 150 Hz)
Test duration per axis	2.5 h

Glow-wire test

Specification	IEC 60998-1:2002-12
Temperature	850 °C
Time of exposure	5 s

Ambient conditions

Ambient temperature (operation)	-40 °C ... 100 °C (Depending on the current carrying capacity/derating curve)
Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C

Packaging specifications

Type of packaging	packed in cardboard
-------------------	---------------------

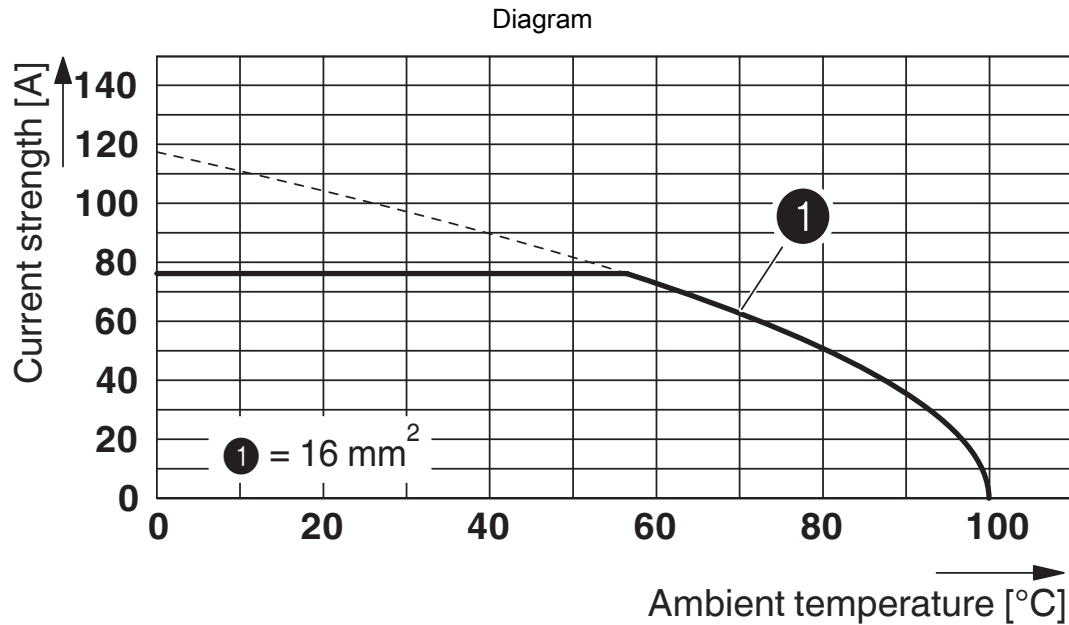
MKDSP 10N/ 2-10,16SZSBDSE RD,ERD - PCB terminal block



1774124

<https://www.phoenixcontact.com/pc/products/1774124>

Drawings



Type: MKDSP 10N/...-10,16

Tested in accordance with DIN EN 60512-5-2:2003-01

Reduction factor = 1

No. of positions: 5

MKDSP 10N/ 2-10,16SZSBDSE RD,ERD - PCB terminal block



1774124

<https://www.phoenixcontact.com/pc/products/1774124>

Classifications

ECLASS

ECLASS-13.0	27460101
-------------	----------

Phoenix Contact 2024 © - all rights reserved

<https://www.phoenixcontact.com>

PHOENIX CONTACT GmbH & Co. KG

Flachsmarktstraße 8

D-32825 Blomberg

+49 (0) 5235-3 00

info@phoenixcontact.com